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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

Details

Product Status	Active
Number of LABs/CLBs	6000
Number of Logic Elements/Cells	48000
Total RAM Bits	4246528
Number of I/O	372
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	672-BBGA
Supplier Device Package	672-FPBGA (27x27)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfe2m50se-5fn672c

Figure 2-1. Simplified Block Diagram, ECP2-6 Device (Top Level)

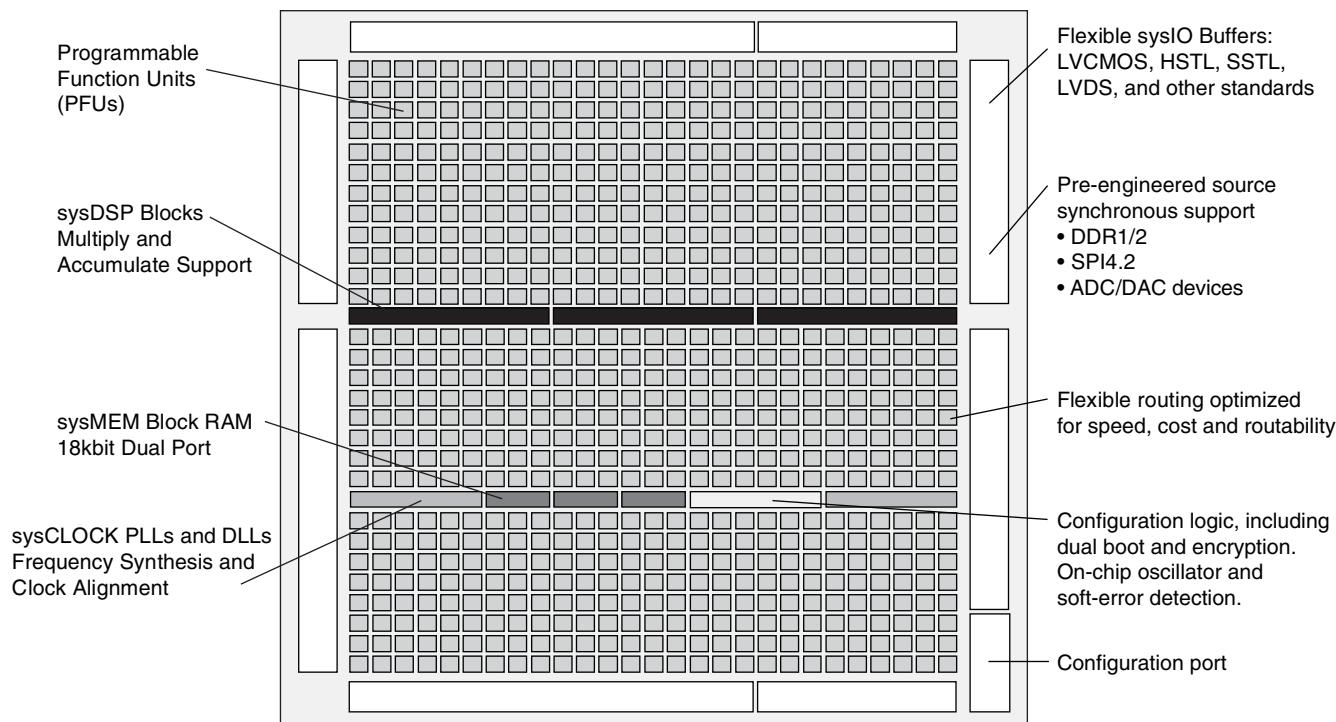


Figure 2-2. Simplified Block Diagram, ECP2M20 Device (Top Level)

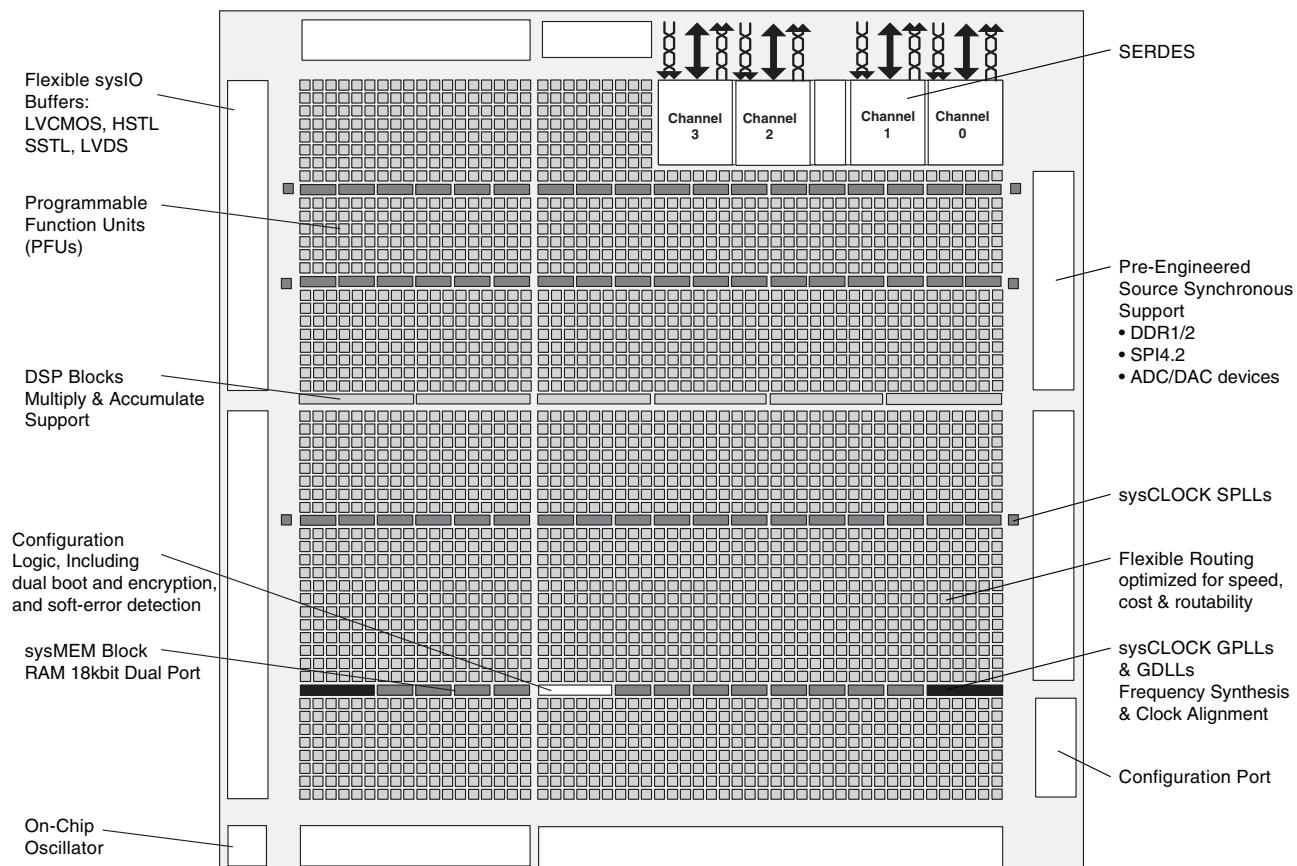


Table 2-14. Supported Output Standards

Output Standard	Drive	V _{CCIO} (Nom.)
Single-ended Interfaces		
LVTTL	4mA, 8mA, 12mA, 16mA, 20mA	3.3
LVCMOS33	4mA, 8mA, 12mA 16mA, 20mA	3.3
LVCMOS25	4mA, 8mA, 12mA, 16mA, 20mA	2.5
LVCMOS18	4mA, 8mA, 12mA, 16mA	1.8
LVCMOS15	4mA, 8mA	1.5
LVCMOS12	2mA, 6mA	1.2
LVCMOS33, Open Drain	4mA, 8mA, 12mA 16mA, 20mA	—
LVCMOS25, Open Drain	4mA, 8mA, 12mA 16mA, 20mA	—
LVCMOS18, Open Drain	4mA, 8mA, 12mA 16mA	—
LVCMOS15, Open Drain	4mA, 8mA	—
LVCMOS12, Open Drain	2mA, 6mA	—
PCI33	N/A	3.3
HSTL18 Class I, II	N/A	1.8
HSTL15 Class I	N/A	1.5
SSTL3 Class I, II	N/A	3.3
SSTL2 Class I, II	N/A	2.5
SSTL18 Class I, II	N/A	1.8
Differential Interfaces		
Differential SSTL3, Class I, II	N/A	3.3
Differential SSTL2, Class I, II	N/A	2.5
Differential SSTL18, Class I, II	N/A	1.8
Differential HSTL18, Class I, II	N/A	1.8
Differential HSTL15, Class I	N/A	1.5
LVDS	N/A	2.5
MLVDS ¹	N/A	2.5
BLVDS ¹	N/A	2.5
LVPECL ¹	N/A	3.3
RSDS ¹	N/A	2.5
LVCMOS33D ¹	4mA, 8mA, 12mA, 16mA, 20mA	3.3

1. Emulated with external resistors. For more detail, please see information regarding additional technical documentation at the end of this data sheet.

Hot Socketing

LatticeECP2/M devices have been carefully designed to ensure predictable behavior during power-up and power-down. During power-up and power-down sequences, the I/Os remain in tri-state until the power supply voltage is high enough to ensure reliable operation. In addition, leakage into I/O pins is controlled within specified limits. This allows for easy integration with the rest of the system. These capabilities make the LatticeECP2/M ideal for many multiple power supply and hot-swap applications.

BLVDS

The LatticeECP2/M devices support the BLVDS standard. This standard is emulated using complementary LVC-MOS outputs in conjunction with a parallel external resistor across the driver outputs. BLVDS is intended for use when multi-drop and bi-directional multi-point differential signaling is required. The scheme shown in Figure 3-2 is one possible solution for bi-directional multi-point differential signals.

Figure 3-2. BLVDS Multi-point Output Example

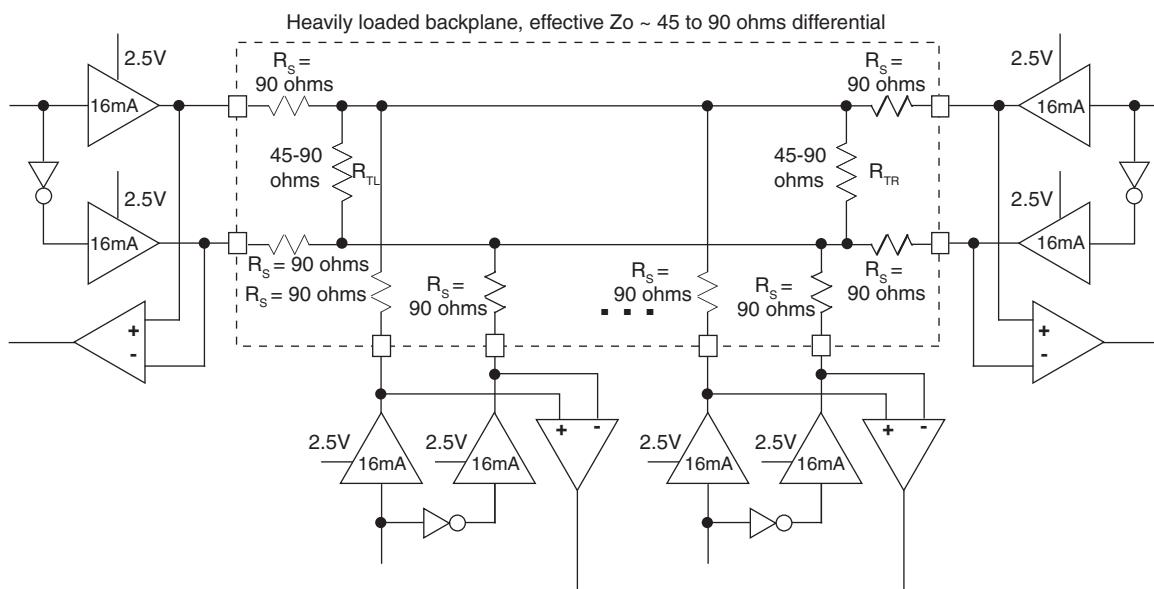


Table 3-3. BLVDS DC Conditions¹

Over Recommended Operating Conditions

Parameter	Description	Typical		Units
		Zo = 45Ω	Zo = 90Ω	
V _{CCIO}	Output Driver Supply (+/- 5%)	2.50	2.50	V
Z _{OUT}	Driver Impedance	10.00	10.00	Ω
R _S	Driver Series Resistor (+/- 1%)	90.00	90.00	Ω
R _{TL}	Driver Parallel Resistor (+/- 1%)	45.00	90.00	Ω
R _{TR}	Receiver Termination (+/- 1%)	45.00	90.00	Ω
V _{OH}	Output High Voltage	1.38	1.48	V
V _{OL}	Output Low Voltage	1.12	1.02	V
V _{OD}	Output Differential Voltage	0.25	0.46	V
V _{CM}	Output Common Mode Voltage	1.25	1.25	V
I _{DC}	DC Output Current	11.24	10.20	mA

1. For input buffer, see LVDS table.

LatticeECP2/M External Switching Characteristics⁹ (Continued)

Over Recommended Operating Conditions

Parameter	Description	Device	-7		-6		-5		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
t_{SU_DEL}	Clock to Data Setup - PIO Input Register with Data Input Delay	LFE2-6	1.40	—	1.70	—	1.90	—	ns
		LFE2-12	1.40	—	1.70	—	1.90	—	ns
		LFE2-20	1.40	—	1.70	—	1.90	—	ns
		LFE2-35	1.40	—	1.70	—	1.90	—	ns
		LFE2-50	1.40	—	1.70	—	1.90	—	ns
		LFE2-70	1.40	—	1.70	—	1.90	—	ns
		LFE2M20	1.40	—	1.70	—	1.90	—	ns
		LFE2M35	1.40	—	1.70	—	1.90	—	ns
		LFE2M50	1.40	—	1.70	—	1.90	—	ns
		LFE2M70	1.40	—	1.70	—	1.90	—	ns
t_{H_DEL}	Clock to Data Hold - PIO Input Register with Input Data Delay	LFE2-6	0.00	—	0.00	—	0.00	—	ns
		LFE2-12	0.00	—	0.00	—	0.00	—	ns
		LFE2-20	0.00	—	0.00	—	0.00	—	ns
		LFE2-35	0.00	—	0.00	—	0.00	—	ns
		LFE2-50	0.00	—	0.00	—	0.00	—	ns
		LFE2-70	0.00	—	0.00	—	0.00	—	ns
		LFE2M20	0.00	—	0.00	—	0.00	—	ns
		LFE2M35	0.00	—	0.00	—	0.00	—	ns
		LFE2M50	0.00	—	0.00	—	0.00	—	ns
		LFE2M70	0.00	—	0.00	—	0.00	—	ns
f_{MAX_IO}	Clock Frequency of I/O Register and PFU Register	ECP2/M	—	420	—	357	—	311	MHz
General I/O Pin Parameters (using Edge Clock without PLL)¹									
t_{COE}	Clock to Output - PIO Output Register	LFE2-6	—	2.60	—	2.90	—	3.20	ns
		LFE2-12	—	2.60	—	2.90	—	3.20	ns
		LFE2-20	—	2.60	—	2.90	—	3.20	ns
		LFE2-35	—	2.60	—	2.90	—	3.20	ns
		LFE2-50	—	2.60	—	2.90	—	3.20	ns
		LFE2-70	—	2.60	—	2.90	—	3.20	ns
		LFE2M20	—	2.60	—	2.90	—	3.20	ns
		LFE2M35	—	2.60	—	2.90	—	3.20	ns
		LFE2M50	—	3.10	—	3.40	—	3.70	ns
		LFE2M70	—	3.10	—	3.40	—	3.70	ns
		LFE2M100	—	3.10	—	3.40	—	3.70	ns

LatticeECP2/M External Switching Characteristics⁹ (Continued)

Over Recommended Operating Conditions

Parameter	Description	Device	-7		-6		-5		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
t_{HPLL}	Clock to Data Hold - PIO Input Register	LFE2-6	1.00	—	1.20	—	1.40	—	ns
		LFE2-12	1.00	—	1.20	—	1.40	—	ns
		LFE2-20	1.00	—	1.20	—	1.40	—	ns
		LFE2-35	1.00	—	1.20	—	1.40	—	ns
		LFE2-50	1.00	—	1.20	—	1.40	—	ns
		LFE2-70	1.00	—	1.20	—	1.40	—	ns
		LFE2M20	1.00	—	1.20	—	1.40	—	ns
		LFE2M35	1.00	—	1.20	—	1.40	—	ns
		LFE2M50	1.00	—	1.20	—	1.40	—	ns
		LFE2M70	1.00	—	1.20	—	1.40	—	ns
t_{SU_DEPLLL}	Clock to Data Setup - PIO Input Register with Data Input Delay	LFE2-6	1.80	—	2.00	—	2.20	—	ns
		LFE2-12	1.80	—	2.00	—	2.20	—	ns
		LFE2-20	1.80	—	2.00	—	2.20	—	ns
		LFE2-35	1.80	—	2.00	—	2.20	—	ns
		LFE2-50	1.80	—	2.00	—	2.20	—	ns
		LFE2-70	1.80	—	2.00	—	2.20	—	ns
		LFE2M20	1.80	—	2.00	—	2.20	—	ns
		LFE2M35	1.80	—	2.00	—	2.20	—	ns
		LFE2M50	1.90	—	2.10	—	2.30	—	ns
		LFE2M70	1.90	—	2.10	—	2.30	—	ns
t_{H_DEPLLL}	Clock to Data Hold - PIO Input Register with Input Data Delay	LFE2-6	0.00	—	0.00	—	0.00	—	ns
		LFE2-12	0.00	—	0.00	—	0.00	—	ns
		LFE2-20	0.00	—	0.00	—	0.00	—	ns
		LFE2-35	0.00	—	0.00	—	0.00	—	ns
		LFE2-50	0.00	—	0.00	—	0.00	—	ns
		LFE2-70	0.00	—	0.00	—	0.00	—	ns
		LFE2M20	0.00	—	0.00	—	0.00	—	ns
		LFE2M35	0.00	—	0.00	—	0.00	—	ns
		LFE2M50	0.00	—	0.00	—	0.00	—	ns
		LFE2M70	0.00	—	0.00	—	0.00	—	ns
		LFE2M100	0.00	—	0.00	—	0.00	—	ns

DDR I/O Pin Parameters²

t_{DVADQ}	Data Valid After DQS (DDR Read)	ECP2/M	—	0.225	—	0.225	—	0.225	UI
t_{DVEDQ}	Data Hold After DQS (DDR Read)	ECP2/M	0.640	—	0.640	—	0.640	—	UI
t_{DQVBS}	Data Valid Before DQS (DDR Write)	ECP2/M	0.250	—	0.250	—	0.250	—	UI
t_{DQVAS}	Data Valid After DQS (DDR Write)	ECP2/M	0.250	—	0.250	—	0.250	—	UI
f_{MAX_DDR}	DDR Clock Frequency ⁶	ECP2/M	95	200	95	166	95	133	MHz

DDR2 I/O Pin Parameters³

t_{DVADQ}	Data Valid After DQS (DDR Read)	ECP2/M	—	0.225	—	0.225	—	0.225	UI
t_{DVEDQ}	Data Hold After DQS (DDR Read)	ECP2/M	0.640	—	0.640	—	0.640	—	UI

LatticeECP2/M Internal Switching Characteristics¹

Over Recommended Operating Conditions

Parameter	Description	-7		-6		-5		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
PFU/PFF Logic Mode Timing								
t _{LUT4_PFU}	LUT4 delay (A to D inputs to F output)	—	0.180	—	0.198	—	0.216	ns
t _{LUT6_PFU}	LUT6 delay (A to D inputs to OFX output)	—	0.304	—	0.331	—	0.358	ns
t _{LSR_PFU}	Set/Reset to output of PFU (Asynchronous)	—	0.600	—	0.655	—	0.711	ns
t _{SUM_PFU}	Clock to Mux (M0,M1) Input Setup Time	0.128	—	0.129	—	0.129	—	ns
t _{HM_PFU}	Clock to Mux (M0,M1) Input Hold Time	-0.051	—	-0.049	—	-0.046	—	ns
t _{SUD_PFU}	Clock to D input setup time	0.061	—	0.071	—	0.081	—	ns
t _{HD_PFU}	Clock to D input hold time	0.002	—	0.003	—	0.003	—	ns
t _{CK2Q_PFU}	Clock to Q delay, (D-type Register Configuration)	—	0.285	—	0.309	—	0.333	ns
PFU Dual Port Memory Mode Timing								
t _{CORAM_PFU}	Clock to Output (F Port)	—	0.902	—	1.083	—	1.263	ns
t _{SUDATA_PFU}	Data Setup Time	-0.172	—	-0.205	—	-0.238	—	ns
t _{HDATA_PFU}	Data Hold Time	0.199	—	0.235	—	0.271	—	ns
t _{SUADDR_PFU}	Address Setup Time	-0.245	—	-0.284	—	-0.323	—	ns
t _{HADDR_PFU}	Address Hold Time	0.246	—	0.285	—	0.324	—	ns
t _{SUWREN_PFU}	Write/Read Enable Setup Time	-0.122	—	-0.145	—	-0.168	—	ns
t _{HWREN_PFU}	Write/Read Enable Hold Time	0.132	—	0.156	—	0.180	—	ns
PIC Timing								
PIO Input/Output Buffer Timing								
t _{IN_PIO}	Input Buffer Delay (LVCMOS25)	—	0.613	—	0.681	—	0.749	ns
t _{OUT_PIO}	Output Buffer Delay (LVCMOS25)	—	1.115	—	1.115	—	1.343	ns
IOLOGIC Input/Output Timing								
t _{SUI_PIO}	Input Register Setup Time (Data Before Clock)	0.596	—	0.645	—	0.694	—	ns
t _{HI_PIO}	Input Register Hold Time (Data after Clock)	-0.570	—	-0.614	—	-0.658	—	ns
t _{COO_PIO}	Output Register Clock to Output Delay	—	0.61	—	0.66	—	0.72	ns
t _{SUCE_PIO}	Input Register Clock Enable Setup Time	0.032	—	0.037	—	0.041	—	ns
t _{HCE_PIO}	Input Register Clock Enable Hold Time	-0.022	—	-0.025	—	-0.028	—	ns
t _{SULSR_PIO}	Set/Reset Setup Time	0.184	—	0.201	—	0.217	—	ns
t _{HLSR_PIO}	Set/Reset Hold Time	-0.080	—	-0.086	—	-0.093	—	ns
EBR Timing								
t _{CO_EBR}	Clock (Read) to output from Address or Data	—	2.51	—	2.75	—	2.99	ns
t _{COO_EBR}	Clock (Write) to output from EBR output Register	—	0.33	—	0.36	—	0.39	ns
t _{SUDATA_EBR}	Setup Data to EBR Memory	-0.157	—	-0.181	—	-0.205	—	ns
t _{HDATA_EBR}	Hold Data to EBR Memory	0.173	—	0.195	—	0.217	—	ns
t _{SUADDR_EBR}	Setup Address to EBR Memory	-0.115	—	-0.130	—	-0.145	—	ns
t _{HADDR_EBR}	Hold Address to EBR Memory	0.138	—	0.155	—	0.172	—	ns
t _{SUWREN_EBR}	Setup Write/Read Enable to PFU Memory	-0.128	—	-0.149	—	-0.170	—	ns

DLL Timing

Over Recommended Operating Conditions

Parameter	Description	Min.	Typ.	Max.	Units
f_{REF}	Input reference clock frequency (on-chip or off-chip)	100	—	500	MHz
f_{FB}	Feedback clock frequency (on-chip or off-chip)	100	—	500	MHz
f_{CLKOP}^1	Output clock frequency, CLKOP	100	—	500	MHz
f_{CLKOS}^2	Output clock frequency, CLKOS	25	—	500	MHz
t_{PJIT}	Output clock period jitter (clean input)		—	250	ps p-p
t_{CYJIT}	Output clock cycle to cycle jitter (clean input)			250	ps p-p
t_{DUTY}	Output clock duty cycle (at 50% levels, 50% duty cycle input clock, 50% duty cycle circuit turned off, time reference delay mode)	35		65	%
$t_{DUTYTRD}$	Output clock duty cycle (at 50% levels, arbitrary duty cycle input clock, 50% duty cycle circuit enabled, time reference delay mode)	40		60	%
$t_{DUTYCIR}$	Output clock duty cycle (at 50% levels, arbitrary duty cycle input clock, 50% duty cycle circuit enabled, clock injection removal mode)	40		60	%
t_{SKEW}^3	Output clock to clock skew between two outputs with the same phase setting	—	—	100	ps
t_{PWH}	Input clock minimum pulse width high (at 80% level)	750	—	—	ps
t_{PWL}	Input clock minimum pulse width low (at 20% level)	750	—	—	ps
t_{INSTB}	Input clock period jitter	—	—	+/-250	ps
t_{LOCK}	DLL lock time	18,500	—	—	cycles
t_{RSWD}	Digital reset minimum pulse width (at 80% level)	3	—	—	ns
t_{PA}	Delay step size	16.5	42	59.4	ps
t_{RANGE1}	Max. delay setting for single delay block (144 taps)	2.376	6	8.553	ns
t_{RANGE4}	Max. delay setting for four chained delay blocks	9.504	24	34.214	ns

1. CLKOP runs at the same frequency as the input clock.

2. CLKOS minimum frequency is obtained with divide by 4.

3. This is intended to be a "path-matching" design guideline and is not a measurable specification.

SERDES External Reference Clock (LatticeECP2M Family Only)

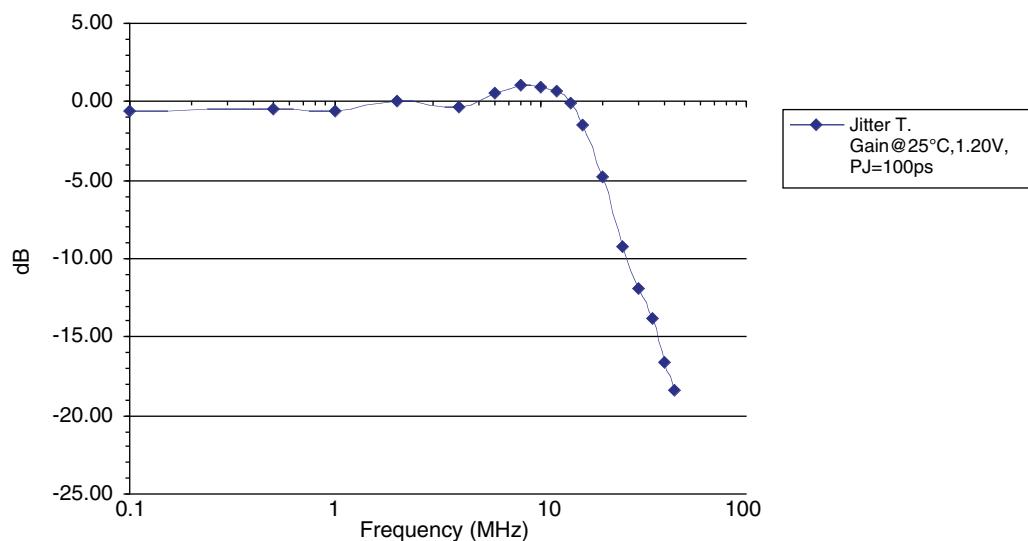
The external reference clock selection and its interface are a critical part of system applications for this product. Table 3-14 specifies reference clock requirements, over the full range of operating conditions.

Table 3-14. External Reference Clock Specification (refclkp/refclkn)

Symbol	Description	Min.	Typ.	Max.	Units
F_{REF}	Frequency range	25	—	320	MHz
$F_{REF-PPM}$	Frequency tolerance	-300	—	300	ppm
$V_{REF-IN-SE}$	Input swing, single-ended clock ¹	100	—	1200	mV, p-p
V_{REF-IN}	Input levels	0	—	$V_{CCP} + 0.8$	V
$V_{REF-CM-DC}$	Input common mode range (DC coupled)	0.5	—	1.2	V
$V_{REF-CM-AC}$	Input common mode range (AC coupled) ²	0	—	1.5	V
D_{REF}	Duty cycle ³	40	—	60	%
T_{REF-R}	Rise time (20% to 80%)		500	1000	ps
T_{REF-F}	Fall time (80% to 20%)		500	1000	ps
$Z_{REF-IN-TERM}$	Input termination		50/2K		Ohms
$C_{REF-IN-CAP}$	Input capacitance ⁴	—	—	1.5	pF

1. The signal swing for a single-ended input clock must be as large as the p-p differential swing of a differential input clock to get the same gain at the input receiver. Lower swings for the clock may be possible, but will tend to increase jitter.
2. When AC coupled, the input common mode range is determined by:
 $(\text{Min input level}) + (\text{Peak-to-peak input swing})/2 \leq (\text{Input common mode voltage}) \leq (\text{Max input level}) - (\text{Peak-to-peak input swing})/2$
3. Measured at 50% amplitude.
4. Input capacitance of 1.5pF is total capacitance, including both device and package.

Figure 3-13. Jitter Transfer



Note: This graph is for a nominal device.

SERDES Power-Down/Power-Up Specification

Table 3-15. Power-Down and Power-Up Specification

Symbol	Description	Max.	Units
t_{PWRDN}	Power-down time after all power down register bits set to '0'	10	μs
t_{PWRUP}	Power-up time after all power down register bits set to '1'	100	μs

LatticeECP2M Pin Information Summary, LFE2M20 and LFE2M35 (Cont.)

Pin Type	LFE2M20		LFE2M35		
	256 fpBGA	484 fpBGA	256 fpBGA	484 fpBGA	672 fpBGA
Available DDR-Interfaces per I/O Bank ¹	Bank0	0	0	0	0
	Bank1	0	0	0	0
	Bank2	0	1	0	1
	Bank3	0	1	0	1
	Bank4	2	4	2	4
	Bank5	1	2	1	2
	Bank6	0	3	0	1
	Bank7	1	2	1	2
	Bank8	0	0	0	0
PCI Capable I/Os per Bank	Bank0	0	0	0	0
	Bank1	0	0	0	0
	Bank2	0	0	0	0
	Bank3	0	0	0	0
	Bank4	32	62	32	62
	Bank5	20	28	20	28
	Bank6	16	40	16	39
	Bank7	28	40	28	40
	Bank8	0	0	0	0

1. Minimum requirement to implement a fully functional 8-bit wide DDR bus. Available DDR interface consists of at least 12 I/Os (1 DQS + 1 DQSB + 8 DQs + 1 DM + Bank VREF1).

LatticeECP2M Pin Information Summary, LFE2M50, LFE2M70 and LFE2M100 (Cont.)

Pin Type		LFE2M50			LFE2M70		LFE2M100	
		484 fpBGA	672 fpBGA	900 fpBGA	900 fpBGA	1152 fpBGA	900 fpBGA	1152 fpBGA
Available DDR-Interfaces per I/O Bank ¹	Bank0	0	0	0	0	0	0	0
	Bank1	0	0	0	0	0	0	0
	Bank2	2	2	2	4	4	4	4
	Bank3	2	1	1	3	4	3	5
	Bank4	3	1	3	3	3	3	3
	Bank5	2	3	3	2	3	2	3
	Bank6	1	2	2	3	4	3	5
	Bank7	3	3	3	4	4	4	5
	Bank8	0	0	0	0	0	0	0
PCI Capable I/Os per Bank	Bank0	0	0	0	0	0	0	0
	Bank1	0	0	0	0	0	0	0
	Bank2	0	0	0	0	72	0	80
	Bank3	0	0	0	0	64	0	80
	Bank4	50	24	48	48	40	48	44
	Bank5	60	60	50	40	40	40	46
	Bank6	52	54	60	62	66	62	82
	Bank7	60	60	68	70	74	70	90
	Bank8	0	0	0	0	0	0	0

1. Minimum requirement to implement a fully functional 8-bit wide DDR bus. Available DDR interface consists of at least 12 I/Os (1 DQS + 1 DQSB + 8 DQs + 1 DM + Bank VREF1).

LatticeECP2M Power Supply and NC (Cont.)

Signal	672 fpBGA	900 fpBGA
V_{CC}	LFE2M35: AD13, AD14, AD16, AD17, AD19, AD21, AD22, AD24, AD25, L12, L13, L14, L15, M11, M12, M15, M16, N11, N16, P11, P16, R11, R12, R15, R16, T12, T13, T14, T15 LFE2M50: L12, L13, L14, L15, M11, M12, M15, M16, N11, N16, P11, P16, R11, R12, R15, R16, T12, T13, T14, T15	LFE2M50: AH1, AH4, AH5, AH2, AH7, AH12, AH9, AH10, AH13, C13, C10, C9, C12, C7, C2, C5, C4, C1, L12, L13, L18, L19, M11, M12, M13, M14, M15, M16, M17, M18, M19, M20, N11, N12, N19, N20, P12, P19, R12, R19, T12, T19, U12, U19, V11, V12, V19, V20, W11, W12, W13, W14, W15, W16, W17, W18, W19, W20, Y12, Y13, Y18, Y19 LFE2M70/LFE2M100: L12, L13, L18, L19, M11, M12, M13, M14, M15, M16, M17, M18, M19, M20, N11, N12, N19, N20, P12, P19, R12, R19, T12, T19, U12, U19, V11, V12, V19, V20, W11, W12, W13, W14, W15, W16, W17, W18, W19, W20, Y12, Y13, Y18, Y19
V_{CCIO0}	B12, B7, F11, J13, K12	D14, E6, E9, F12, K12, K13
V_{CCIO1}	D18, F16, J14, K15	D17, E22, E25, F19, K18, K19
V_{CCIO2}	G25, L21, M17, M25, N18	F28, J25, K28, M21, M24, N21, N28, P21, R25
V_{CCIO3}	P18, R17, R25, T21, Y25	AA28, AB25, AE28, T25, U21, V21, V28, W21, W24
V_{CCIO4}	AA16, AC18, U15, V14	AA18, AA19, AE19, AF22, AG17, AG25
V_{CCIO5}	AA11, AE12, AE7, U12, V13	AA12, AA13, AE12, AF9, AG14, AG6
V_{CCIO6}	P9, R10, R2, T6, Y2	AA3, AB6, AE3, T6, U10, V10, V3, W10, W7
V_{CCIO7}	G2, L6, M10, M2, N9	F3, J6, K3, M10, M7, N10, N3, P10, R6
V_{CCIO8}	AC24, U17	AA25, AD28
V_{CCJ}	AA7	AG1
V_{CCAUX}	LFE2M35: AE19, J11, J12, J15, J16, L18, L9, M18, M9, R18, R9, T18, T9, V11, V12, V15, V16 LFE2M50: J11, J12, J15, J16, L18, L9, M18, M9, R18, R9, T18, T9, V11, V12, V15, V16	LFE2M50: AJ7, B7, AA10, AA11, AA20, AA21, K10, K11, K20, K21, L10, L11, L20, L21, Y10, Y11, Y20, Y21 LFE2M70/LFE2M100: AA10, AA11, AA20, AA21, K10, K11, K20, K21, L10, L11, L20, L21, Y10, Y11, Y20, Y21
V_{CCPLL}	H7, K6, P7, R8, V18, P20, J17, G19	N13, N18, V13, V18
SERDES Power ³	LFE2M35: C25, B25, C22, A22, C21, C20, C24, C23, B19, C19, C15, C14, C18, C17, A16, C16, B13, C13 LFE2M50: AD13, AE13, AD16, AF16, AD17, AD18, AD14, AD15, AD19, AE19, AD23, AD24, AD20, AD21, AF22, AD22, AE25, AD25, C25, B25, C22, A22, C21, C20, C24, C23, B19, C19, C15, C14, C18, C17, A16, C16, B13, C13	LFE2M50: AH18, AJ18, AH21, AK21, AH22, AH23, AH19, AH20, AH24, AJ24, AH28, AH29, AH25, AH26, AK27, AH27, AJ30, AH30, C30, B30, C27, A27, C26, C25, C29, C28, B24, C24, C20, C19, C23, C22, A21, C21, B18, C18 LFE2M70/LFE2M100: C13, B13, C10, A10, C9, C8, C12, C11, B7, C7, C3, C2, C6, C5, A4, C4, B1, C1, C30, B30, C27, A27, C26, C25, C29, C28, B24, C24, C20, C19, C23, C22, A21, C21, B18, C18, AH18, AJ18, AH21, AK21, AH22, AH23, AH19, AH20, AH24, AJ24, AH28, AH29, AH25, AH26, AK27, AH27, AJ30, AH30, AH1, AJ1, AH4, AK4, AH5, AH6, AH2, AH3, AH7, AJ7, AH11, AH12, AH8, AH9, AK10, AH10, AJ13, AH13

LFE2-6E/SE and LFE2-12E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2-6E/SE					LFE2-12E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
F15	PR11B	2	RDQ10	C	PR11B	2	RDQ10	C
G11	PR12B	2	RDQ10	C (LVDS)*	PR12B	2	RDQ10	C (LVDS)*
F14	PR11A	2	RDQ10	T	PR11A	2	RDQ10	T
VCCIO	VCCIO2	2			VCCIO2	2		
F12	PR12A	2	RDQ10	T (LVDS)*	PR12A	2	RDQ10	T (LVDS)*
G14	PR10B	2	RDQ10	C (LVDS)*	PR10B	2	RDQ10	C (LVDS)*
G13	PR10A	2	RDQS10	T (LVDS)*	PR10A	2	RDQS10	T (LVDS)*
GND	GNDIO2	-			GNDIO2	-		
F16	PR8B	2	RDQ10	C (LVDS)*	PR8B	2	RDQ10	C (LVDS)*
F9	PR9B	2	RDQ10	C	PR9B	2	RDQ10	C
E16	PR8A	2	RDQ10	T (LVDS)*	PR8A	2	RDQ10	T (LVDS)*
F10	PR9A	2	RDQ10	T	PR9A	2	RDQ10	T
VCCIO	VCCIO2	2			VCCIO2	2		
D16	PR7B	2	RDQ10	C	PR7B	2	RDQ10	C
D15	PR7A	2	RDQ10	T	PR7A	2	RDQ10	T
C15	PR4B	2		C (LVDS)*	PR4B	2		C (LVDS)*
C16	PR5B	2		C	PR5B	2		C
GND	GNDIO2	-			GNDIO2	-		
D14	PR4A	2		T (LVDS)*	PR4A	2		T (LVDS)*
B16	PR5A	2		T	PR5A	2		T
F13	PR2B	2	VREF2_2	C (LVDS)*	PR2B	2	VREF2_2	C (LVDS)*
VCCIO	VCCIO2	2			VCCIO2	2		
E13	PR2A	2	VREF1_2	T (LVDS)*	PR2A	2	VREF1_2	T (LVDS)*
F11	PT28B	1	VREF2_1	C	PT55B	1	VREF2_1	C
E11	PT28A	1	VREF1_1	T	PT55A	1	VREF1_1	T
GND	GNDIO1	-			GNDIO1	-		
A15	PT27B	1		C	PT54B	1		C
E12	PT26B	1		C	PT53B	1		C
B15	PT27A	1		T	PT54A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
D12	PT26A	1		T	PT53A	1		T
B14	PT25B	1		C	PT52B	1		C
C14	PT24B	1		C	PT51B	1		C
A14	PT25A	1		T	PT52A	1		T
D13	PT24A	1		T	PT51A	1		T
C13	PT23B	1		C	PT50B	1		C
GND	GNDIO1	-			GNDIO1	-		
A13	PT22B	1		C	PT49B	1		C
B13	PT23A	1		T	PT50A	1		T
VCCIO	VCCIO1	1			VCCIO1	1		
A12	PT22A	1		T	PT49A	1		T
B11	PT21B	1		C	PT48B	1		C
D11	PT20B	1		C	PT47B	1		C
A11	PT21A	1		T	PT48A	1		T
C11	PT20A	1		T	PT47A	1		T

LFE2-20E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2-20E/SE					
Ball Number	Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
J13	J13	PR28B	3	RLM0_GDLLC_FB_A/RDQ25	C
J12	J12	PR28A	3	RLM0_GDLLT_FB_A/RDQ25	T
H12	H12	PR27B	3	RLM0_GDLLC_IN_A**/RDQ25	C (LVDS)*
GND	GND	GNDIO3	-		
H13	H13	PR27A	3	RLM0_GDLLT_IN_A**/RDQ25	T (LVDS)*
H15	H15	PR22B	3	VREF2_3/RDQ25	C
VCCIO	VCCIO	VCCIO3	3		
H16	H16	PR22A	3	VREF1_3/RDQ25	T
H11	H11	PR21B	3	PCLKC3_0/RDQ25	C (LVDS)*
J11	J11	PR21A	3	PCLKT3_0/RDQ25	T (LVDS)*
G16	G16	PR19B	2	PCLKC2_0/RDQ16	C
GND	GND	GNDIO2	-		
G15	G15	PR19A	2	PCLKT2_0/RDQ16	T
F15	F15	PR17B	2	RDQ16	C
G11	G11	PR18B	2	RDQ16	C (LVDS)*
F14	F14	PR17A	2	RDQ16	T
VCCIO	VCCIO	VCCIO2	2		
F12	F12	PR18A	2	RDQ16	T (LVDS)*
G14	G14	PR16B	2	RDQ16	C (LVDS)*
G13	G13	PR16A	2	RDQS16	T (LVDS)*
GND	GND	GNDIO2	-		
F16	F16	PR14B	2	RDQ16	C (LVDS)*
F9	F9	PR15B	2	RDQ16	C
E16	E16	PR14A	2	RDQ16	T (LVDS)*
F10	F10	PR15A	2	RDQ16	T
VCCIO	VCCIO	VCCIO2	2		
D16	D16	PR13B	2	RDQ16	C
D15	D15	PR13A	2	RDQ16	T
C15	C15	PR6B	2	RDQ8	C (LVDS)*
C16	C16	PR7B	2	RDQ8	C
GND	GND	GNDIO2	-		
D14	D14	PR6A	2	RDQ8	T (LVDS)*
B16	B16	PR7A	2	RDQ8	T
F13	F13	PR2B	2	VREF2_2	C (LVDS)*
VCCIO	VCCIO	VCCIO2	2		
E13	E13	PR2A	2	VREF1_2	T (LVDS)*
F11	F11	PT64B	1	VREF2_1	C
E11	E11	PT64A	1	VREF1_1	T
GND	GND	GNDIO1	-		
A15	A15	PT63B	1		C
E12	E12	PT62B	1		C
B15	B15	PT63A	1		T

LFE2-20E/SE and LFE2-35E/SE Logic Signal Connections: 672 fpBGA (Cont.)

LFE2-20E/20SE					LFE2-35E/35SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
N15	GND	-			GND	-			
N17	GND	-			GND	-			
P10	GND	-			GND	-			
P12	GND	-			GND	-			
P13	GND	-			GND	-			
P14	GND	-			GND	-			
P15	GND	-			GND	-			
P17	GND	-			GND	-			
R13	GND	-			GND	-			
R14	GND	-			GND	-			
T10	GND	-			GND	-			
T11	GND	-			GND	-			
T16	GND	-			GND	-			
T17	GND	-			GND	-			
T24	GND	-			GND	-			
T3	GND	-			GND	-			
U10	GND	-			GND	-			
U11	GND	-			GND	-			
U13	GND	-			GND	-			
U14	GND	-			GND	-			
U16	GND	-			GND	-			
U17	GND	-			GND	-			
V13	GND	-			GND	-			
V14	GND	-			GND	-			
V21	GND	-			GND	-			
V6	GND	-			GND	-			
M3	NC	-			NC	-			
N6	NC	-			NC	-			
P24	NC	-			NC	-			

* Supports true LVDS. Other differential signals must be emulated with external resistors.

** These dedicated input pins can be used for GPLLS or GDLLs within the respective quadrant.

***Due to packaging bond out option, this DQS does not have all the necessary DQ pins bonded out for a full 8-bit data width.

Note: VCCIO and GND pads are used to determine the average DC current drawn by I/Os between GND/VCCIO connections, or between the last GND/VCCIO in an I/O bank and the end of an I/O bank. The substrate pads listed in the Pin Table do not necessarily have a one to one connection with a package ball or pin.

LFE2M-20E/SE and LFE2M-35E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2M20E/SE					LFE2M35E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
GNDIO	GNDIO6	-			GNDIO6	-		
L1	PL42A	6	LLM0_GPLLTT_IN_A	T (LVDS)*	PL57A	6	LLM0_GPLLTT_IN_A**/LDQS57***	T (LVDS)*
GNDIO	GNDIO6	-			GNDIO6	-		
L2	PL42B	6	LLM0_GPLLC_IN_A	C (LVDS)*	PL57B	6	LLM0_GPLLC_IN_A**/LDQ57	C(LVDS)*
L3	PL43A	6	LLM0_GPLLTT_FB_A	T	PL58A	6	LLM0_GPLLTT_FB_A/LDQ57	T
L4	PL43B	6	LLM0_GPLLC_FB_A	C	PL58B	6	LLM0_GPLLC_FB_A/LDQ57	C
VCCIO	VCCIO6	6			VCCIO6	6		
M1	PL44A	6	LLM0_GDLLT_IN_A	T (LVDS)*	PL59A	6	LLM0_GDLLT_IN_A**/LDQ57	T (LVDS)*
N1	PL44B	6	LLM0_GDLLC_IN_A	C (LVDS)*	PL59B	6	LLM0_GDLLC_IN_A**/LDQ57	C(LVDS)*
N2	PL45A	6	LLM0_GDLLT_FB_A	T	PL60A	6	LLM0_GDLLT_FB_A/LDQ57	T
N3	PL45B	6	LLM0_GDLLC_FB_A	C	PL60B	6	LLM0_GDLLC_FB_A/LDQ57	C
GNDIO	GNDIO6	-			GNDIO6	-		
M4	LLM0_PLLCAP	6			LLM0_PLLCAP	6		
VCCIO	VCCIO6	6			VCCIO6	6		
GNDIO	GNDIO6	-			GNDIO6	-		
K6	TCK	-			TCK	-		
L5	TDI	-			TDI	-		
N4	TMS	-			TMS	-		
N6	TDO	-			TDO	-		
K7	VCCJ	-			VCCJ	-		
M5	PB2A	5	BDQ6	T	PB2A	5	BDQ6	T
N5	PB2B	5	BDQ6	C	PB2B	5	BDQ6	C
L6	PB3A	5	BDQ6	T	PB3A	5	BDQ6	T
M6	PB3B	5	BDQ6	C	PB3B	5	BDQ6	C
P3	PB4A	5	BDQ6	T	PB4A	5	BDQ6	T
VCCIO	VCCIO5	5			VCCIO5	5		
P4	PB4B	5	BDQ6	C	PB4B	5	BDQ6	C
P2	PB5A	5	BDQ6	T	PB5A	5	BDQ6	T
P1	PB5B	5	BDQ6	C	PB5B	5	BDQ6	C
R1	PB6A	5	BDQS6	T	PB6A	5	BDQS6	T
GNDIO	GNDIO5	-			GNDIO5	-		
R2	PB6B	5	BDQ6	C	PB6B	5	BDQ6	C
R3	PB7A	5	BDQ6	T	PB7A	5	BDQ6	T
T2	PB7B	5	BDQ6	C	PB7B	5	BDQ6	C
R4	PB8A	5	BDQ6	T	PB8A	5	BDQ6	T
VCCIO	VCCIO5	5			VCCIO5	5		
T3	PB8B	5	BDQ6	C	PB8B	5	BDQ6	C
T4	PB10A	5	BDQ6	T	PB10A	5	BDQ6	T
GNDIO	GNDIO5	-			GNDIO5	-		
T5	PB10B	5	BDQ6	C	PB10B	5	BDQ6	C
VCCIO	VCCIO5	5			VCCIO5	5		
GNDIO	GNDIO5	-			GNDIO5	-		
T6	PB16A	5	VREF2_5/BDQ15	T	PB34A	5	VREF2_5/BDQ33	T
R6	PB16B	5	VREF1_5/BDQ15	C	PB34B	5	VREF1_5/BDQ33	C
P6	PB17A	5	PCLKT5_0/BDQ15	T	PB35A	5	PCLKT5_0/BDQ33	T
P7	PB17B	5	PCLKC5_0/BDQ15	C	PB35B	5	PCLKC5_0/BDQ33	C
VCCIO	VCCIO5	5			VCCIO5	5		
GNDIO	GNDIO5	-			GNDIO5	-		

LFE2M-20E/SE and LFE2M-35E/SE Logic Signal Connections: 256 fpBGA (Cont.)

LFE2M20E/SE					LFE2M35E/SE			
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
F14	PR24B	2	RDQ22	C (LVDS)*	PR34B	2	RDQ32	C(LVDS)*
F13	PR24A	2	RDQ22	T (LVDS)*	PR34A	2	RDQ32	T (LVDS)*
VCCIO	VCCIO2	2			VCCIO2	2		
GNDIO	GNDIO2	-			GNDIO2	-		
H11	PR14B	2		C	PR14B	2	RDQ15	C
G11	PR14A	2		T	PR14A	2	RDQ15	T
E13	PR13B	2		C (LVDS)*	PR13B	2	RDQ15	C(LVDS)*
F12	PR13A	2		T (LVDS)*	PR13A	2	RDQ15	T (LVDS)*
VCCIO	VCCIO2	2			VCCIO2	2		
F11	PR12B	2	RUM0_SPLLC_FB_A	C	PR12B	2	RUM0_SPLLC_FB_A/RDQ15	C
E12	PR12A	2	RUM0_SPLLT_FB_A	T	PR12A	2	RUM0_SPLLT_FB_A/RDQ15	T
D16	PR11B	2	RUM0_SPLLC_IN_A	C (LVDS)*	PR11B	2	RUM0_SPLLC_IN_A/RDQ15	C(LVDS)*
D15	PR11A	2	RUM0_SPLLT_IN_A	T (LVDS)*	PR11A	2	RUM0_SPLLT_IN_A/RDQ15	T (LVDS)*
C16	PR9B	2	VREF2_2	C	PR9B	2	VREF2_2	C
GNDIO	GNDIO2	-			GNDIO2	-		
B16	PR9A	2	VREF1_2	T	PR9A	2	VREF1_2	T
VCCIO	VCCIO2	2			VCCIO2	2		
F4	XRES	-			XRES	-		
C15	URC_SQ_VCCRX0	12			URC_SQ_VCCRX0	12		
A14	URC_SQ_HDINP0	12		T	URC_SQ_HDINP0	12		T
B15	URC_SQ_VCCIB0	12			URC_SQ_VCCIB0	12		
B14	URC_SQ_HDINN0	12		C	URC_SQ_HDINN0	12		C
C12	URC_SQ_VCCTX0	12			URC_SQ_VCCTX0	12		
A11	URC_SQ_HDOUTP0	12		T	URC_SQ_HDOUTP0	12		T
A12	URC_SQ_VCCOB0	12			URC_SQ_VCCOB0	12		
B11	URC_SQ_HDOUTN0	12		C	URC_SQ_HDOUTN0	12		C
C11	URC_SQ_VCCTX1	12			URC_SQ_VCCTX1	12		
B10	URC_SQ_HDOUTN1	12		C	URC_SQ_HDOUTN1	12		C
C10	URC_SQ_VCCOB1	12			URC_SQ_VCCOB1	12		
A10	URC_SQ_HDOUTP1	12		T	URC_SQ_HDOUTP1	12		T
C14	URC_SQ_VCCRX1	12			URC_SQ_VCCRX1	12		
B13	URC_SQ_HDINN1	12		C	URC_SQ_HDINN1	12		C
C13	URC_SQ_VCCIB1	12			URC_SQ_VCCIB1	12		
A13	URC_SQ_HDINP1	12		T	URC_SQ_HDINP1	12		T
B9	URC_SQ_VCCAUX33	12			URC_SQ_VCCAUX33	12		
D8	URC_SQ_REFCLKN	12		C	URC_SQ_REFCLKN	12		C
D9	URC_SQ_REFCLKP	12		T	URC_SQ_REFCLKP	12		T
C9	URC_SQ_VCCP	12			URC_SQ_VCCP	12		
A5	URC_SQ_HDINP2	12		T	URC_SQ_HDINP2	12		T
C5	URC_SQ_VCCIB2	12			URC_SQ_VCCIB2	12		
B5	URC_SQ_HDINN2	12		C	URC_SQ_HDINN2	12		C
C4	URC_SQ_VCCRX2	12			URC_SQ_VCCRX2	12		
A8	URC_SQ_HDOUTP2	12		T	URC_SQ_HDOUTP2	12		T
C8	URC_SQ_VCCOB2	12			URC_SQ_VCCOB2	12		
B8	URC_SQ_HDOUTN2	12		C	URC_SQ_HDOUTN2	12		C
C7	URC_SQ_VCCTX2	12			URC_SQ_VCCTX2	12		
B7	URC_SQ_HDOUTN3	12		C	URC_SQ_HDOUTN3	12		C
A6	URC_SQ_VCCOB3	12			URC_SQ_VCCOB3	12		

LFE2M20E/SE and LFE2M35E/SE Logic Signal Connections: 484 fpBGA (Cont.)

LFE2M20E/SE					LFE2M35E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential	
L4	PL24B	7	LDQ22	C (LVDS)*	PL34B	7	LDQ32	C (LVDS)*	
M1	PL25A	7	PCLKT7_0/LDQ22	T	PL35A	7	PCLKT7_0/LDQ32	T	
GNDIO	GNDIO7	-			GNDIO7	-			
M2	PL25B	7	PCLKC7_0/LDQ22	C	PL35B	7	PCLKC7_0/LDQ32	C	
M6	PL27A	6	PCLKT6_0	T (LVDS)*	PL37A	6	PCLKT6_0	T (LVDS)*	
M5	PL27B	6	PCLKC6_0	C (LVDS)*	PL37B	6	PCLKC6_0	C (LVDS)*	
M3	PL28A	6	VREF2_6	T	PL38A	6	VREF2_6	T	
M4	PL28B	6	VREF1_6	C	PL38B	6	VREF1_6	C	
VCCIO	VCCIO6	6			VCCIO6	6			
N7	PL31A	6	LLM1_SPLL_IN_A	T (LVDS)*	PL41A	6	LLM2_SPLL_IN_A	T (LVDS)*	
GNDIO	GNDIO6	-			GNDIO6	-			
N6	PL31B	6	LLM1_SPLL_IN_A	C (LVDS)*	PL41B	6	LLM2_SPLL_IN_A	C (LVDS)*	
N1	PL32A	6	LLM1_SPLL_FB_A	T	PL42A	6	LLM2_SPLL_FB_A	T	
N2	PL32B	6	LLM1_SPLL_FB_A	C	PL42B	6	LLM2_SPLL_FB_A	C	
VCCIO	VCCIO6	6			VCCIO6	6			
GNDIO	GNDIO6	-			GNDIO6	-			
P6	PL38A	6	LDQS38****	T (LVDS)*	PL48A	6	LDQS48****	T (LVDS)*	
N5	PL38B	6	LDQ38	C (LVDS)*	PL48B	6	LDQ48	C (LVDS)*	
P1	PL39A	6	LDQ38	T	PL49A	6	LDQ48	T	
VCCIO	VCCIO6	6			VCCIO6	6			
P2	PL39B	6	LDQ38	C	PL49B	6	LDQ48	C	
P3	PL40A	6	LDQ38	T (LVDS)*	PL50A	6	LDQ48	T (LVDS)*	
P4	PL40B	6	LDQ38	C (LVDS)*	PL50B	6	LDQ48	C (LVDS)*	
P5	PL41A	6	LDQ38	T	PL51A	6	LDQ48	T	
GNDIO	GNDIO6	-			GNDIO6	-			
P7	PL41B	6	LDQ38	C	PL51B	6	LDQ48	C	
R1	PL42A	6	LLM0_GPLL_IN_A**	T (LVDS)*	PL57A	6	LLM0_GPLL_IN_A**/LDQS57****	T (LVDS)*	
GNDIO	GNDIO6	-			GNDIO6	-			
R2	PL42B	6	LLM0_GPLL_IN_A**	C (LVDS)*	PL57B	6	LLM0_GPLL_IN_A**/LDQ57	C (LVDS)*	
R3	PL43A	6	LLM0_GPLL_FB_A	T	PL58A	6	LLM0_GPLL_FB_A/ LDQ57	T	
R4	PL43B	6	LLM0_GPLL_FB_A	C	PL58B	6	LLM0_GPLL_FB_A/ LDQ57	C	
VCCIO	VCCIO6	6			VCCIO6	6			
R6	PL44A	6	LLM0_GDLLT_IN_A**	T (LVDS)*	PL59A	6	LLM0_GDLLT_IN_A**/LDQ57	T (LVDS)*	
R5	PL44B	6	LLM0_GDLLC_IN_A**	C (LVDS)*	PL59B	6	LLM0_GDLLC_IN_A**/LDQ57	C (LVDS)*	
T1	PL45A	6	LLM0_GDLLT_FB_A	T	PL60A	6	LLM0_GDLLT_FB_A/ LDQ57	T	
T2	PL45B	6	LLM0_GDLLC_FB_A	C	PL60B	6	LLM0_GDLLC_FB_A/ LDQ57	C	
GNDIO	GNDIO6	-			GNDIO6	-			
R7	LLM0_PLLCAP	6			LLM0_PLLCAP	6			
T6	PL47A	6	LDQ51	T (LVDS)*	PL62A	6	LDQ66	T (LVDS)*	
T7	PL47B	6	LDQ51	C (LVDS)*	PL62B	6	LDQ66	C (LVDS)*	
U1	PL48A	6	LDQ51	T	PL63A	6	LDQ66	T	
U2	PL48B	6	LDQ51	C	PL63B	6	LDQ66	C	
VCCIO	VCCIO6	6			VCCIO6	6			
T3	PL49A	6	LDQ51	T (LVDS)*	PL64A	6	LDQ66	T (LVDS)*	
U3	PL49B	6	LDQ51	C (LVDS)*	PL64B	6	LDQ66	C (LVDS)*	
U6	PL50A	6	LDQ51	T	NC	-			
U5	PL50B	6	LDQ51	C	PL65B	6	LDQ66	C	
GNDIO	GNDIO6	-			GNDIO6	-			

LFE2M100E/SE Logic Signal Connections: 900 fpBGA (Cont.)

LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential
M10	VCCIO7	7		
M7	VCCIO7	7		
N10	VCCIO7	7		
N3	VCCIO7	7		
P10	VCCIO7	7		
R6	VCCIO7	7		
AA25	VCCIO8	8		
AD28	VCCIO8	8		
AA10	VCCAUX	-		
AA11	VCCAUX	-		
AA20	VCCAUX	-		
AA21	VCCAUX	-		
K10	VCCAUX	-		
K11	VCCAUX	-		
K20	VCCAUX	-		
K21	VCCAUX	-		
L10	VCCAUX	-		
L11	VCCAUX	-		
L20	VCCAUX	-		
L21	VCCAUX	-		
Y10	VCCAUX	-		
Y11	VCCAUX	-		
Y20	VCCAUX	-		
Y21	VCCAUX	-		
A1	GND	-		
A13	GND	-		
A18	GND	-		
A24	GND	-		
A30	GND	-		
A7	GND	-		
AA14	GND	-		
AA15	GND	-		
AA16	GND	-		
AA17	GND	-		
AA24	GND	-		
AA27	GND	-		
AA4	GND	-		
AB24	GND	-		
AB7	GND	-		
AD12	GND	-		
AD19	GND	-		
AD27	GND	-		
AE22	GND	-		

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
GNDIO	GNDIO5	-			GNDIO5	-		
AE16	PB42B	5	BDQ42	C	PB51B	5	BDQ51	C
AF15	PB44A	5	BDQ42	T	PB53A	5	BDQ51	T
VCCIO	VCCIO5	5			VCCIO5	5		
AD16	PB44B	5	BDQ42	C	PB53B	5	BDQ51	C
AK17	PB45A	5	BDQ42	T	PB54A	5	BDQ51	T
AH16	PB45B	5	BDQ42	C	PB54B	5	BDQ51	C
AN16	PB46A	5	BDQ42	T	PB55A	5	BDQ51	T
GNDIO	GNDIO5	-			GNDIO5	-		
AP16	PB46B	5	BDQ42	C	PB55B	5	BDQ51	C
AL17	PB47A	5	BDQ51	T	PB56A	5	BDQ60	T
AM17	PB47B	5	BDQ51	C	PB56B	5	BDQ60	C
AN17	PB48A	5	BDQ51	T	PB57A	5	BDQ60	T
AP17	PB48B	5	BDQ51	C	PB57B	5	BDQ60	C
AD17	PB49A	5	BDQ51	T	PB58A	5	BDQ60	T
AE17	PB49B	5	BDQ51	C	PB58B	5	BDQ60	C
VCCIO	VCCIO5	5			VCCIO5	5		
AL18	PB50A	5	BDQ51	T	PB59A	5	BDQ60	T
AM18	PB50B	5	BDQ51	C	PB59B	5	BDQ60	C
GNDIO	GNDIO5	-			GNDIO5	-		
AP18	PB51A	5	BDQS51	T	PB60A	5	BDQS60	T
AN18	PB51B	5	BDQ51	C	PB60B	5	BDQ60	C
AG17	PB52A	5	VREF2_5/BDQ51	T	PB61A	5	VREF2_5/BDQ60	T
AJ17	PB52B	5	VREF1_5/BDQ51	C	PB61B	5	VREF1_5/BDQ60	C
AF17	PB53A	5	PCLKT5_0/BDQ51	T	PB62A	5	PCLKT5_0/BDQ60	T
AH17	PB53B	5	PCLKC5_0/BDQ51	C	PB62B	5	PCLKC5_0/BDQ60	C
VCCIO	VCCIO5	5			VCCIO5	5		
GNDIO	GNDIO5	-			GNDIO5	-		
AF18	PB58A	4	PCLKT4_0/BDQ60	T	PB67A	4	PCLKT4_0/BDQ69	T
VCCIO	VCCIO4	4			VCCIO4	4		
AD18	PB58B	4	PCLKC4_0/BDQ60	C	PB67B	4	PCLKC4_0/BDQ69	C
AP19	PB59A	4	VREF2_4/BDQ60	T	PB68A	4	VREF2_4/BDQ69	T
AN19	PB59B	4	VREF1_4/BDQ60	C	PB68B	4	VREF1_4/BDQ69	C
AP20	PB60A	4	BDQS60	T	PB69A	4	BDQS69	T
GNDIO	GNDIO4	-			GNDIO4	-		
AM20	PB60B	4	BDQ60	C	PB69B	4	BDQ69	C
AN20	PB61A	4	BDQ60	T	PB70A	4	BDQ69	T
AM21	PB61B	4	BDQ60	C	PB70B	4	BDQ69	C
AG18	PB62A	4	BDQ60	T	PB71A	4	BDQ69	T
VCCIO	VCCIO4	4			VCCIO4	4		
AE18	PB62B	4	BDQ60	C	PB71B	4	BDQ69	C
AJ18	PB63A	4	BDQ60	T	PB72A	4	BDQ69	T
AH18	PB63B	4	BDQ60	C	PB72B	4	BDQ69	C
AK18	PB64A	4	BDQ60	T	PB73A	4	BDQ69	T
GNDIO	GNDIO4	-			GNDIO4	-		
AK19	PB64B	4	BDQ60	C	PB73B	4	BDQ69	C
AP21	PB65A	4	BDQ69	T	PB74A	4	BDQ78	T
AN21	PB65B	4	BDQ69	C	PB74B	4	BDQ78	C
AL20	PB66A	4	BDQ69	T	PB75A	4	BDQ78	T

LFE2M70E/SE and LFE2M100E/SE Logic Signal Connections: 1152 fpBGA (Cont.)

LFE2M70E/SE				LFE2M100E/SE				
Ball Number	Ball/Pad Function	Bank	Dual Function	Differential	Ball/Pad Function	Bank	Dual Function	Differential
AN29	LRC_SQ_VCCRX2	13			LRC_SQ_VCCRX2	13		
AM28	LRC_SQ_HDINN2	13		C	LRC_SQ_HDINN2	13		C
AL27	LRC_SQ_VCCIB2	13			LRC_SQ_VCCIB2	13		
AM29	LRC_SQ_HDINP2	13		T	LRC_SQ_HDINP2	13		T
AL29	LRC_SQ_VCCP	13			LRC_SQ_VCCP	13		
AL30	LRC_SQ_REFCLKP	13		T	LRC_SQ_REFCLKP	13		T
AK30	LRC_SQ_REFCLKN	13		C	LRC_SQ_REFCLKN	13		C
AK29	LRC_SQ_VCCAUX33	13			LRC_SQ_VCCAUX33	13		
AM30	LRC_SQ_HDINP1	13		T	LRC_SQ_HDINP1	13		T
AL31	LRC_SQ_VCCIB1	13			LRC_SQ_VCCIB1	13		
AM31	LRC_SQ_HDINN1	13		C	LRC_SQ_HDINN1	13		C
AN30	LRC_SQ_VCCRX1	13			LRC_SQ_VCCRX1	13		
AP30	LRC_SQ_HDOUTP1	13		T	LRC_SQ_HDOUTP1	13		T
AL32	LRC_SQ_VCCOB1	13			LRC_SQ_VCCOB1	13		
AP31	LRC_SQ_HDOUTN1	13		C	LRC_SQ_HDOUTN1	13		C
AN31	LRC_SQ_VCCTX1	13			LRC_SQ_VCCTX1	13		
AP32	LRC_SQ_HDOUTN0	13		C	LRC_SQ_HDOUTN0	13		C
AM34	LRC_SQ_VCCOB0	13			LRC_SQ_VCCOB0	13		
AP33	LRC_SQ_HDOUTP0	13		T	LRC_SQ_HDOUTP0	13		T
AN32	LRC_SQ_VCCTX0	13			LRC_SQ_VCCTX0	13		
AM32	LRC_SQ_HDINN0	13		C	LRC_SQ_HDINN0	13		C
AN34	LRC_SQ_VCCIB0	13			LRC_SQ_VCCIB0	13		
AM33	LRC_SQ_HDINP0	13		T	LRC_SQ_HDINP0	13		T
AN33	LRC_SQ_VCCRX0	13			LRC_SQ_VCCRX0	13		
AH28	CFG2	8			CFG2	8		
AD24	CFG1	8			CFG1	8		
AJ29	CFG0	8			CFG0	8		
AF25	PROGRAMN	8			PROGRAMM	8		
AJ28	CCLK	8			CCLK	8		
AE25	INITN	8			INITN	8		
AK31	DONE	8			DONE	8		
GNDIO	GNDIO8	-			GNDIO8	-		
AE24	WRITEN***	8			WRITEN***	8		
AJ30	CS1N***	8			CS1N***	8		
AD25	CSN***	8			CSN***	8		
AG29	D0/SPIFASTN***	8			D0/SPIFASTN***	8		
VCCIO	VCCIO8	8			VCCIO8	8		
AG28	D1***	8			D1***	8		
AG30	D2***	8			D2***	8		
AH29	D3***	8			D3***	8		
GNDIO	GNDIO8	-			GNDIO8	-		
AF26	D4***	8			D4***	8		
AH30	D5***	8			D5***	8		
AE26	D6***	8			D6***	8		
AJ31	D7/SPID0***	8			D7/SPID0***	8		
VCCIO	VCCIO8	8			VCCIO8	8		
AG27	DI/CSSPI0N***	8			DI/CSSPI0N***	8		
AK32	DOUT/CS0N/ CSSPI1N***	8			DOUT/CS0N/ CSSPI1N***	8		
AK33	BUSY/SISPI***	8			BUSY/SISPI***	8		